# Fact Sheet

# Military SemiconductorProducts THS4031M/5962-9959501QxA SGYV090, May 2000

### 120-MHZ LOW-NOISE, HIGH-SPEED AMPLIFIER

#### HIGHLIGHTS

The THS4031 is an ultra-low voltage noise, high-speed, voltage feedback amplifier that is ideal for applications requiring low voltage noise, including communication and imaging. The THS4031 offers very good AC performance with 120-MHz bandwidth, 100-V/ $\mu$ s slew rate, and 60-ns settling time (0.1%). The THS4031 is stable at gains of 2 (-1) or greater. This amplifier has a high drive capability of 90 mA and draws only 8.5-mA supply current. With total harmonic distortion (THD) of -81 dBc at f = 1 MHz, the THS4031 is ideally suited for applications requiring low distortion.

### **KEY FEATURES/BENEFITS**

- Ultra-low 1.6-nV/√(Hz) \Voltage Noise
- High Speed
  - 120-MHz Bandwidth (G = 2 (-1), -3 dB)
  - 100-V/µs Slew Rate
- Stable in Gains of 2 (-1) or greater
- Very Low Distortion
  - THD = -81 dBc (f = 1 MHz, RL = 150Ω)
  - THD = -96 dBc (f = 1 MHz, RL = 1 k $\Omega$ )
- Low 0.5-mV (Typ) Input Offset Voltage
- 90-mA Output Current Drive (Typical)
- ±5-V to ±15-V Typical Operation

#### DIE SIZE

The current die has a size of: 40 mils x 39 mils.

### TECHNOLOGY

- BICOM-1
- ESD level: 1 kV

### PACKAGING

Package Option: 8

8-pin Ceramic Dual in Line Package (JG ) 20-pin Leadless Ceramic Chip Carrier (FK)



#### POWER DISSIPATION

The table below shows modeled data. This data can be used for approximating system thermal characteristics:

Package	RqJA	RqJC
8-pin DIP	180ºC/W	14.52°C/W
20-pin LCC	65°C/W*	22°C/W*
*		

## Package Thermal Data

\*modeled data

Note: much better thermal impedances can be achieved by using air flow or by increasing metal backplane thickness or trace area in the Printed Circuit Board (PCB) that is used.

#### **PROCESS/PERFORMANCE OPTIONS**

The THS4031MxxB are processed to MIL-PRF-38535. The DSCC Standard Microcircuit Drawings (SMD) for this device is given below.

TI Parent	DSCC SMD	
THS4031MFKB	5962-9959501Q2A	
THS4031MJGB	5962-9959501QPA	
THS4031MJG	N/A	

#### DSCC SMD

#### SUPPORT

You can access data sheets via TI's home page on the internet (http://www.ti.com) or reference the literature number SLOS224C when contacting the Product Information Center (PIC).

For additional information on this and other Mixed Signal/Analog Products, contact the PIC or visit our Mixed Signal home page at:

http://www.ti.com/sc/docs/military/product/mix\_sig/mixsig\_1.htm

#### **Product Information Center**

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